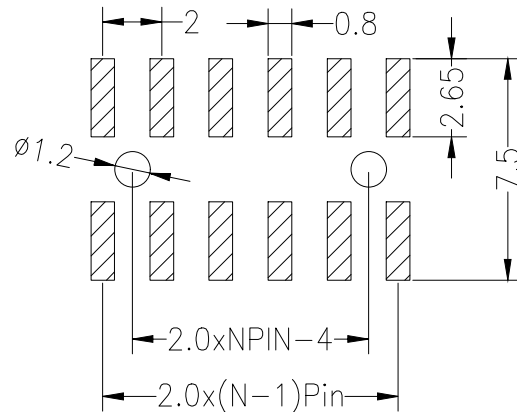
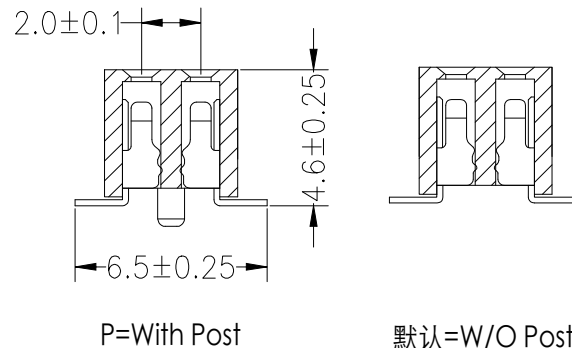
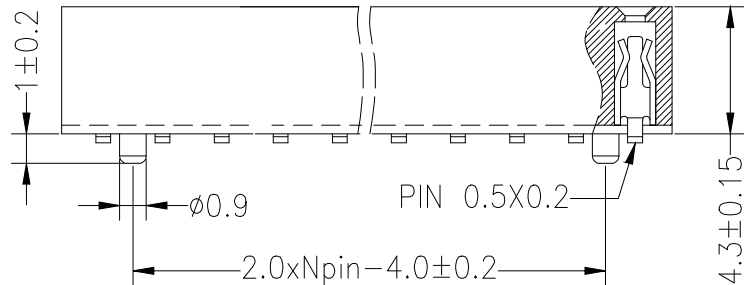


Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



SPECIFICATIONS
Rated Current:1.5AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:-40°C to +105°C

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V-0)
Standard: PA6T
Max.Processing Temp: 230°C for 30-60 seconds
(260°C for 10 seconds)



Ordering Information

XDM 200 - * - N - S - * - ** - P

| | | | | | |
|---|--------------------------|---------------------------------------|--------------|--|--|
| No. of Rows 1=Single Row 2=Dual Row | No. of Pins 01-40 Pin | Type Z=直针 W=弯针 S=插板 WS=带插 | Length 距离 | Contact Plating G0:Gold Flash G1:1u" Gold G2:2u" Gold G3:5u" Gold G4:10u" Gold G5:15u" Gold G6:30u" Gold S0:Gold Flash/Tin S1:Tin | 默认=W/O Post 无柱 P=With Post 带柱 |
|---|--------------------------|---------------------------------------|--------------|--|--|

| | | | | | | | | |
|-----------|------------------------|-------------------|-------------------|------------------|---|-----------------------|-------------|-----|
| | | | GENERAL TOLERANCE | 制图 DRAWING | 深圳讯答科技有限公司 ShenzhenXundaTechnology Co.,Ltd | | | |
| | | | DIM TOL | 审核 CHECK | | | | |
| | | | X.X ±0.30 | 批准 APPROVAL | 产品名称 TITLE | 2.00 双排 贴片 排母 (塑高4.3) | 版本 REV. | A |
| | | | X.XX ±0.20 | 比例 SCALE | 产品料号 PART NO. | XDM200-2-N-S-4.3-G0 | 单位 UNITS | mm |
| | | | X.XXX ±0.10 | 投影 Projection | 材料 MATERIAL | | 页次 SHEET | 1/1 |
| 1 | 初版发行 | | Angle ±3.0° | | | | | |
| 序号 No. | 变更内容 MODIFY CONTENT | 日期 MODIFY DATE | | | | | | |